

# **DesignWare Cores LPDDR54 PHY Diagnostic Firmware Application Note**

**DWC LPDDR54 PHY** 

Firmware Version: C-2020.11

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## **2** Revision History

Document Revision	Date	Description
1.40a	December 7, 2020	Updated:
		Adding Figure 1 Initialization Flow.
		Updating to C-2020.11
1.30	September 4, 2020	Updated:
		5.10 Test 10 : Mode Register
		Read
		Updating to A/B-2020-09
1.20	June 10, 2020	Updated
1.10	April 30, 2020	Initial release

## 3 Reference Documents

The following reference documents are used in this application note:

DesignWare Cores LPDDR54 SDRAM PHY Databook, Synopsys, Inc.

DesignWare Cores LPDDR54 Utility Block (PUB) Release Notes, Synopsys, Inc.

## 4 Introduction



This application note pertains to A-2019.01 version of the DWC DDRPHY Diagnostic firmware. There may be variations in operation, interface, and usage procedure, depending on the DWC DDRPHY Diagnostic firmware version

### 4.1 Purpose

The DWC DDRPHY Diagnostic Firmware is a software tool to obtain diagnostic information from a trained DDR system.

This is delivered as firmware image which contains a number of tests that may be used to troubleshoot or measure the PHY-DRAM link.

In addition to the descriptions of the individual tests, the process for loading and running the firmware, including the prerequisite steps are described.

Since the nature of many of the diagnostic tests involve placing the memory system beyond its typical operating limits, the system is not supported to run mission mode traffic after the diagnostics complete. After performing the diagnostics, the system is required to be reset/reinitialize or powered off.



The DWC DDRPHY Diagnostic Firmware is a utility intended for diagnostic debug purposes. The DWC DDRPHY Diagnostic Firmware is not intended for production use

## 4.2 Overview and Pre-Requisites

The PHY Diagnostic firmware may be executed immediately following PHY training.

In the case of a system with multiple trained pstates – it is up to the user to appropriately choose when to run the diagnostics.

Assuming the example Training + mission mode sequence below:

- a. Train -P0 @3200
- b. DFI Initialization @ PO

The sequence may be interrupted after completion of any of the training steps (a,b,c); and proceed to diagnostics instead of continuing with the complete sequence. The following (Figure 1) shows the differences between the standard training + mission mode flow and the PHY Diagnostic flow.

For the Diagnostic Firmware sequence to execute, the PHY must be in the following state:

- Previous Training step executed as expected and returned Message 0x7 [Firmware complete]
- The complete message block from the previous training step is preserved in the PHY DMEM.
- The DFICLK is stable and operating at the same frequency as the previous training step.
- The PHY Register MicroReset = 0x1
- The PHY Register MicroContMuxSel = 0x0
- The PHY Register UcclkHclkEnables= 0x3

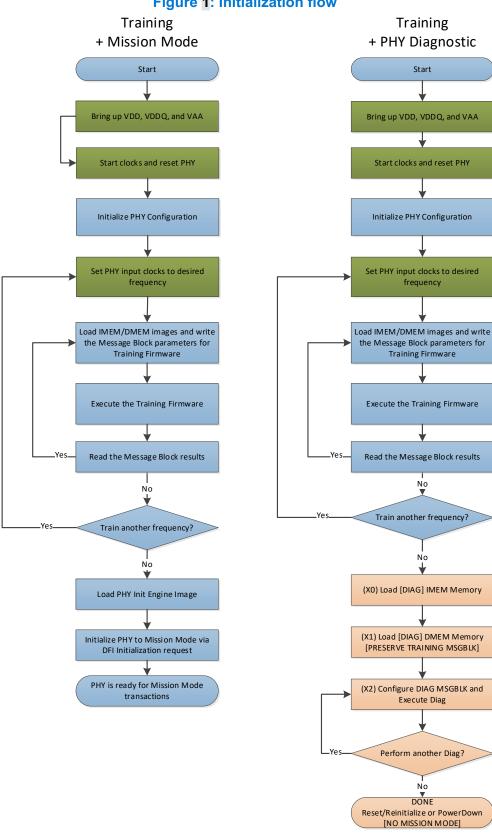


Figure 1: Initialization flow

The Diagnostic Firmware does not alter the mode register state (except where required by the specific test-type), and relies on the DRAM state to be initialized by the preceding training steps.

In LPDDR4 systems the following dram mode register settings must be constrained if Diagnostics Firmware will be run (mode registers not listed may be set as desired). Individual tests may have additional limitations, refer to the descriptions for each test for further details.

LPDDR4 Mode Register #	Constrained Values	Comments
MR13	OP[3] = {1}	VRCG must be in high current mode for Diags
MR16	OP[7:0] = {0,0,0,0,0,0,0,0}	PASR Mode not supported by Diags
MR17	OP[7:0] = {0,0,0,0,0,0,0,0}	PASR Mode not supported by Diags
MR24	OP[7:4] = {0,0,0,0}	TRR Mode not supported by Diags

In DDR4 systems the following dram mode register settings must be constrained if Diagnostics Firmware will be run (mode registers not listed may be set as desired). Individual tests may have additional limitations, refer to the descriptions for each test for further details.

DDR4 Mode Register #	Constrained Values	Comments
MR0	A[1:0] = {0,1} or {0,0}	Fixed BC4 not supported by Diags
MR0	$A[7] = \{0\}$	TM not supported by Diags
MR1	$A[0] = \{1\}$	DLL-off mode not supported by Diags
MR1	A[12] = {0}	DRAM output buffers must be enabled
MR2	A[12] = {0}	WCRC not supported by Diags
MR2	A[13,8,2,1,0] = {0,0,0,0,0}	TRR Mode not supported by Diags
MR4	$A[1] = \{0\}$	MPSM Mode not supported by Diags
MR4	A[8,7,6] = {0,0,0}	CS to CMD Latency not supported by
		Diags
MR4	A[13,5] = {0,0}	PPR mode not supported by Diags
MR5	A[9,4,3,2,1,0] = {0,0,0,0,0,0}	DRAM CMD Parity not supported by Diags

In DDR4 RDIMM systems, the following Register control word settings must be constrained. These constraints are in addition to the DDR4 dram restrictions listed above.

RCD Control Word #	Constrained Values	Comments
FORCOO	DA[3,2,0] = {0,0,0}	Only normal RCD operation mode supported
FORCO2	DA[3,2] = {0,0}	Only normal RCD operation mode supported
FORCO6	CMD{6,7,8,10} not allowed	RCD Parity and RCD geardown not supported
FORCO9	DA[3] = {1}	Clock Stop Power Down Mode is required
FORCOA	DA[2:0] != {1,1,1}	RCD PLL Bypass mode not supported
FORCOA	$DA[3] = \{0\}$	Only RCD Context 1 supported
FORCOC	DA[3:0] = {0,0,0,0}	Only normal RCD operation mode supported
FORCOD	DA[3] = {1}	Only normal RCD operation mode supported
FORCOE	$DA[0] = \{0\}$	RCD Parity not supported

## 4.3 Load Diag IMEM and DMEM (Step X0, X1)

Loading the firmware is accomplished by accessing the PMU SRAMs over the APB bus or JTAG. The SRAMs are mapped into the APB address space starting at address 0x50000 for the instruction memory and 0x58000 for the data memory, out of which the initial 1KB is reserved for training firmware message block. The diagnostic firmware message block starts at 0x58200.

The Diagnostic firmware requires up to 32KB of instruction memory and up to 15KB of data memory. The firmware is provided in two formats:

- Binary image (.bin files)
- Text files with APB address/data pairs (.incv files)

The two formats contain identical firmware images, and the user can use whichever format is more convenient. To use the APB address / data pairs file, write each address with the associated data. To use the binary image file, write the binary contents of the file 16 bits at a time to the memory.

There is a separate file for:

- the instruction memory image (XXX diags imem.bin or XXX diags imem.incv)
- the data memory image (XXX\_diags\_dmem.bin or XXX\_diag\_dmem.incv)

Where **XXX** is correct protocol for the trained dram.

Both the instruction memory and the data memory image must be loaded. The instruction memory image contains the executable training code. The data memory image contains data structures that the instruction memory image needs to run.

After running the previous training step, the training messageblock is still resident in the PHY SRAM data memory. If the messageblock is not overwritten by the user, it does not need to be reloaded. The full address regions for the Preserved Training Message block, Diag FW IMEM, and Diag FW DMEM is shown in Table 4-1 PHY SRAM Address Map.

Table 4-1 PHY SRAM Address Map

Image	Start Address	End Address	Data Width per address increment
DIAG FW IMEM	0x50000	0x53FFF (32kB)	16
Preserved Training MsgBlk	0x58000	0x581FF (1kB)	16
DIAG FW DMEM	0x58200	0x55FFF (15kB)	16

<b>3</b> .35→ Note	After loading with the Binary image (.bin files), it is necessary to reload the original content of trainning's message block content, that is from 0x58000 ~ 0x581ff. There is no need to reload training's message block if using Text files with APB address/data pairs (.incv files).
<b>3</b> Son Note	While loading firmware IMEM/DMEM images, the csrMicroReset must be set so that {Reset = 0; stall =1 }.

## 4.4 Configure Diag Message Block and Execute (Step X2)

To run the desired test, the Diagnostics message block needs to be configured. The exact settings needed will vary by test. Refer to Section 4.3 for information on the size and location of the diagnostics message block and chapter 5 for details regarding the individual diagnostic tests.

The diagnostics execution process is as follows:

1. Configure the Diagnostic Message block with the desired message block

2.	Reset 1 <sup>st</sup> Microcontroller Message Protocol Bit	[write PHY Register UctWriteProt	= 0x1
3.	Reset 2 <sup>nd</sup> Microcontroller Message Protocol Bit	[write PHY Register DctWriteProt	= 0x1
4.	Reset Microcontroller Message	[write PHY Register UctWriteOnly	= 0x0]
5.	Set control of the internal CSR bus to the PMU	[write PHY Register MicroContMuxSel	= 0x1
6.	Assert PMU Reset and Stall	[write PHY Register MicroReset	= 0x9
7.	De-assert PMU Reset only	[write PHY Register MicroReset	= 0x1
8.	De-assert PMU Stall	[write PHY Register MicroReset	= 0x0

9. Wait for the Diagnostics test to finish

[Poll PHY Register UctWriteOnlyShadow until a completion message is received] See Table 4-2 Mailbox Message Values

10. Assert PMU Stall [write PHY Register MicroReset = 0x1]

- 11. Set control of the internal CSR bus to the APB [write PHY Register MicroContMuxSel = 0x0]
- 12. Read back diagnostics return data per test.

  Refer to each test for details of the return data format

If additional tests are desired, repeat the above execution process.

**Table 4-2 Mailbox Message Values** 

UctWriteOnlyShadow Value	Message meaning
0x00	Reset Value
0x07	Diagnostics finished successfully (firmware complete)
0xFF	Abnormal exit (firmware complete)

### 4.5 Diagnostics Message Block

The diagnostics firmware has a message block area to allow for configuring of the test and returning of the data. There are three major sections of the message block, the 1D configuration block, the Diagnostics Message block and the return data.

The beginning of the message block area is the 1D message block which needs to be preserved from 1D training. The location is the same is used in 1D training. The 1D message block area is preserved so the Diagnostics Firmware knows the current state of the PHY and the DRAM so that it can correctly execute the test.

The diagnostics message block follows the 1D message block. It is located 0x400 bytes past the beginning of the 1D message block at CSR Address 0x58200. It contains the information needed to choose and configure the Diagnostic tests. The names of the arguments are described in the header file format below

#### **Table 4-3 Diagnostics Message Block Definition**

```
typedef struct _PMU_SMB_DIAG_t {
   uint8 t DiagTestNum;
                             // Byte offset 0x400, CSR Addr 0x58200, Direction=N/A
                             // Byte offset 0x401, CSR Addr 0x58200, Direction=N/A
   uint8 t DiagSubTest;
   uint8 t DiagPrbs;
                             // Byte offset 0x402, CSR Addr 0x58201, Direction=N/A
                             // Byte offset 0x403, CSR Addr 0x58201, Direction=N/A
   uint8 t DiagRank;
                             // Byte offset 0x404, CSR Addr 0x58202, Direction=N/A
   uint8 t DiagChannel;
   uint8 t DiagRepeatCount;
                            // Byte offset 0x405, CSR Addr 0x58202, Direction=N/A
                             // Byte offset 0x406, CSR Addr 0x58203, Direction=N/A
   uint8 t DiagLoopCount;
   uint8 t DiagByte;
                             // Byte offset 0x407, CSR Addr 0x58203, Direction=N/A
   uint8 t DiagLane;
                             // Byte offset 0x408, CSR Addr 0x58204, Direction=N/A
                             // Byte offset 0x409, CSR Addr 0x58204, Direction=N/A
   uint8 t DiagVrefInc;
                             // Byte offset 0x40a, CSR Addr 0x58205, Direction=N/A
   uint8 t DiagReserved0A;
   uint8 t DiagXCount;
                             // Byte offset 0x40b, CSR Addr 0x58205, Direction=N/A
   uint16 t DiagAddrLow;
                             // Byte offset 0x40c, CSR Addr 0x58206, Direction=N/A
  uint16_t DiagAddrHigh;
                             // Byte offset 0x40e, CSR Addr 0x58207, Direction=N/A
   uint16 t DiagPatternLow;
                             // Byte offset 0x410, CSR Addr 0x58208, Direction=N/A
   uint16 t DiagPatternHigh;
                            // Byte offset 0x412, CSR Addr 0x58209, Direction=N/A
                             // Byte offset 0x414, CSR Addr 0x5820a, Direction=N/A
   uint8 t DiagMisc0;
   uint8 t DiagMisc1;
                             // Byte offset 0x415, CSR Addr 0x5820a, Direction=N/A
   uint8 t DiagMisc2;
                             // Byte offset 0x416, CSR Addr 0x5820b, Direction=N/A
   uint8 t DiagReserved17;
                             // Byte offset 0x417, CSR Addr 0x5820b, Direction=N/A
   uint8 t DiagReserved3F;
                             // Byte offset 0x43F, CSR Addr 0x5821F, Direction=N/A
   uint16 t DiagReturnData;
                              // Byte offset 0x440, CSR Addr 0x58220, Direction=N/A
                              // This byte offset is the pointer to the first address
                              // of the DiagReturnData ; please see individual tests for
                              // details of the data structure
   } attribute__ ((packed)) PMU_SMB_DIAG_t;
```

The location of the message block areas are shown in Table 4-3 Message Block Address Map.

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**Table 4-4 Message Block Address Map** 

Section	CSR Address	DMEM offset (bytes)
1D Message block	0x58000	0x00
Diagnostics Message block	0x58200	0x400
Data Return Data	0x58220	0x440

The last item in the Diagnostics message block is the DiagReturnData field. It points to the beginning of the return data, the format of which varies between tests. The field is defined as two bytes long in the header, but the return data size is defined by the test that is being run.

## 4.6 Simulating Diagnostics

When running diagnostics in RTL simulation, memory models may flag certain protocol violations. Refresh requirements, such as tRASmax are not always met and some tests (such as the READ test) may use unititialized data. In these cases those errors can be ignored or waived.

# 5 Diagnostic Test Details

## 5.1 Diagnostic Functions Overview

The following table describes the tests that are available for each of the supported DRAM protocols. The Diagnostic Firmware supports multiple protocols, not all Diagnostic routines work with all protocols. Only the diagnostic routines supported by the customer PHY should be used

Test Number	Test	LPDDR4	LPDDR5
1	Reserved		
2	Send Burst Writes	SUPPORTED	SUPPORTED
3	Send Burst Reads	SUPPORTED	SUPPORTED
4	Simple Write Read	SUPPORTED	SUPPORTED
5	Write Eye	SUPPORTED	SUPPORTED
6	Read Eye	SUPPORTED	SUPPORTED
7			
8			
9	Mode register write	SUPPORTED	SUPPORTED
А	Mode register read	SUPPORTED	SUPPORTED
В	Reserved		
С	Reserved		
D	Reserved		
Е	Reserved		
F	Reserved		

## 5.2 Adjusting Test Run Time

The diagnostic tests allow for the number of bursts per run to be adjusted using the messageblock parameters DiagXCnt, DiagLoopCount, and DiagRepeatCount. Tests that support these looping variables have an internal loop following the below pseudocode.

This can be summarized in an equation for the number of bursts sent/received per test run.

```
BurstCount = DiagXCnt * (1+DiagLoopCount)*(1+DiagRepeatCount).
```

Tests can offset loop variables, such as making DiagLoopCount specify multiples of 255. When calculating the number of bursts a test will run, it's important to take these offsets into account as part of the loop variables they modify.

### 5.3 PPGC configuration

All the diagnostics tests have either/both of these two DRAM operations:

- WR command to DRAM to send the pattern specified by DiagPrbs
- RD command to receive back pattern specified by DiagPrbs

To make sure that the PPGC sends correct data on the DiagLane during write operation and uses correct data to compare the received data, the hardware mode to generate DBI lane pattern is used. Each DQ lane and DBI lane carries depending upon diagnostics' message block configuration (DiagLane, DiagPrbs) and the feature status of ReadDbi and WriteDbi. In the case of PRBS mode, PRBS is sent and received on every lane. In the case of pattern mode, data is only sent on the lane under test, and the other lanes are static, 0 in the case of LPDDR4 and 1 in the case of DDR4.

#### 5.4 TEST 0x2 : Send Burst Writes

"Send burst writes" test generates large amounts of write traffic on the bus for customers to observe the trained-behavior of their system during writes. During the burst write test, the phy will send continuous write bursts to the row address provided in two different banks (or bank groups for DDR4), nominally generating write data on all lanes using the input data-pattern. There is a break in DQ traffic continuity for every DiagLoopCount iteration.

Field Used	Range	Description
DiagPrbs	[0,2]	0: Reserved
		1: Prbs23 mode
		2: pattern mode
DiagRepeatCount	[0,255]	Number of bursts per loop
DiagLoopCount	[0,255]	How many loops to run (multiples of 255)
DiagXCnt	[0,255]	How many times to iterate (0 and 1 will iterate once)
DiagRank		Which rank to test
DiagAddrHigh, DiagAddrLow		Row address to activate
DiagPatternHigh, DiagPatternLow		32 bit-time repeating Pattern to send when
		[ DiagPrbs==2 pattern mode ]
DiagMisc4[1]	[0,1]	0: finite burst write
		1: infinite burst write (DiagLoopCount & DiagXCount are ignored)

```
Example test pseudocode:

For DiagXCnt {

For (DiagLoopCount*255) {

Write diagAddr diagRepeatCount times
}//for
}//for
```

No data is returned by the write memory test and there is no guarantee that the written data will persist in memory once the test has ended.

When in pattern mode, the data pattern restarts at every iteration of the DiagXcnt Loop.

#### 5.5 TEST 0x3 : Send Burst Reads

The send burst read test generates large amounts of read traffic on the bus for customers to observe the trained-behavior of their system during reads.

The burst read test issues DiagRepeatCount times READ commands for alternating banks, to read data from the specified row. There is a break in DQ traffic continuity for every DiagLoopCount iteration.

Field Used	Range	Description
DiagRepeatCount	[0,255]	Number of repeated bursts per loop
DiagLoopCount	[0,255]	How many repeated loops to run (multiples of 255)
DiagXCnt	[0,255]	How many times to iterate (0 and 1 will iterate once)
DiagRank		Which rank to test
DiagAddrHigh, DiagAddrLow		Row address to activate
DiagMisc4[1]	[0,1]	0: finite burst read 1: infinite burst read (DiagLoopCount & DiagXCount are ignored)

#### Example test pseudocode:

#### Limitations:

The data received on DQ lanes is completely random as there's no WR operation involved in this test.

## 5.6 TEST 0x4 : Simple Write Read

Field Used	Range	Description
DiagPrbs	[0,2]	0: Reserved
		1: Prbs23 mode
		2: pattern mode
DiagRepeatCount	[0, 127]	Number of extra bursts per loop(DiagMisc1=2)
	[Don't care]	If DiagMisc1=0
DiagLoopCount	[0, 255]	Number of extra bursts per loop
DiagRank		Which rank to test
DiagAddrHigh, DiagAddrLow		Row address to activate
DiagPatternHigh, DiagPatternLow		32 bit-time repeating Pattern to send when
		[ DiagPrbs==2 pattern mode ]

The simple write read test quickly proves that writes and reads to the dram devices are working.

Normally, the write read test sends 63 continuous writes to the target row address using the data pattern provided. The write burst is followed by a read burst checking the contents of the memory addresses just written. If DiagLoopCount is non-zero, the target row will then be overwritten and read back another DiagLoopCount times.

The simple read write test returns data with the following encodings.

Table 5-1 Read Write Diag pass/fail data

Value	Description
0x0	Lane passed
0x1	Lane failed
0xff	Lane was not tested

Results are reported beginning at the address tied to the DiagReturnData messageblock field. Each piece of data is one byte in width. The first byte of the return data is a global pass/fail; it will be set to 1 if any lane in the phy saw errors. The rest of the results report on a per-lane basis which lanes saw errors (1) or ran without issue (0).

Current firmware only supports the read fifo option, which results in a fixed number of reads and writes for each loop iteration, which is 8 for LPDDR5 and 4 for LPDDR4.

**Table 2-2 Read Write Test Return Data** 

Byte Offset	Result	Size in Bytes
0	Pass/Fail	1
1	Reserved	1
2	Dbyte 0 Lane 0 pass/fail	1
3	Dbyte 0 Lane 1 pass/fail	1
4	Dbyte 0 Lane 2 pass/fail	1
6	Dbyte 0 Lane 3 pass/fail	1
7	Dbyte 0 Lane 4 pass/fail	1
8	Dbyte 0 Lane 5 pass/fail	1
9	Dbyte 0 Lane 6 pass/fail	1
10	Dbyte 0 Lane 7 pass/fail	1
11	Dbyte 0 Lane 8 pass/fail	1
12	Dbyte 1 Lane 0 pass/fail	1
2+(9*N)+M	Dbyte N Lane M pass fail	1

The sequence for this test is as follows:

- 1. All DRAMS on all channels and ranks are sent the exit power down command
- 2. All channels and ranks are sent the exit self-refresh command
- 3. The row address specified in DiagAddrLow and DiagAddrHigh is activated
- 4. The test is run on both channels and the selected rank for DiagLoopCount+1 iterations
- 5. The complete row is written
- 6. The complete row is read
- 7. The hardware training registers is checked for errors
- 8. All lanes are set to either pass fail or not tested
- 9. All channels and ranks are sent the enter self-refresh command
- 10. All channels and ranks are sent the power down command
- 11. The tests exits

## **5.7 TEST 0x5 : Tx Eye**

Field Used	Range	Description	
DiagPrbs	[0,2]	0: Reserved	
		1: Prbs23 mode 2: pattern mode	
		·	
DiagRepeatCount	[0, 127]	Number of extra bursts per loop(DiagMisc1=2)	
	[Don't care]	If DiagMisc1=0	
DiagLoopCount	[0,255]	How many extra loops to run	
DiagXCnt	[0,255]	How many times to iterate (0 and 1 will iterate once)	
DiagByte		Which byte to measure	
DiagLane	[0,8]	Which dq to measure in DiagByte	
	[9]	[LPDDR5 only] measure Write Data Link ECC, MR22[6:4]=1 is required.	
DiagRank		Which rank to test	
DiagAddrHigh, DiagAddrLow		Row address to activate	
DiagPatternHigh, DiagPatternLow		Pattern to send when DiagPrbs is 2 (pattern mode)	
DiagVrefInc	[1, 127]	Controls granularity of voltage domain. Larger number means less resolution.	
DiagMisc0	DiagMisc0 = 0	No filtering	
	DiagMisc0 = 1	Ignore odd bits	
	DiagMisc0 = 2	Ignore even bits	
		All other values reserved	
DiagMisc1	DiagMisc1 = 0	Use Write Read FIFO	
<b>5</b>		Reserved	
		All other values reserved	

The TxEye test collects the transmit eye associated with a specifc byte and bit. The eye is measured by running traffic while varying the DRAM VREF and Phy's TxDq delay settings. The test records how many errors occur at each delay and voltage setting and returns a matrix of encoded error counts through the DiagReturnData messageblock field.

TxEye sends a continuous group of DiagRepeatCount write bursts to the target row address using the data pattern provided. The write burst is followed by a continuous group of DiagRepeatCount read burst checking the contents of the memory addresses just written. If DiagLoopCount or diagXCnt is non-zero, the target row will then be overwritten and read back another DiagLoopCount\*DiagXCnt times. Once finished the test reads the errors on the target lane and stores the results. TxEye repeats this set of reads and writes for the powerset of all device voltages and txDqDelay settings, storing values all the while.

Error counts for each (delay,voltage) pair are 16 bit values compressed into a single byte to save space. The compression scheme is as follows.

Compressed Result Value	Actual Error count
X=[0x0,0x7f]	X
X=[0x80,0xfe]	(X&0x7f) <<7 (approximate)
X=0xff	> 16256 (approximate)

DiagReturnData's results for TxEye are mapped as described below, including the dimensions of the error matrix (nVref x nDly) and the center point found by previous training stages in addition to the error matrix itself. Please note that the data starts with the minimum voltage and increases until the maximum voltage.

Byte Offset	Description	Size in Bytes
0	Number of Delays (nDly)	1
1	Number of Vrefs (nVREF)	1
2	Trained DRAM VREF	1
3	Reserved	1
4	Trained TxDqDelay CSR Value	2
6	Error Count (Delay=0, Vref=0)	1
6+nDly	Error Count (Delay=nDly, Vref=0)	1
7+nDly	Error Count (Delay=0, Vref=1)	1
6+(2*nDly)	Error Count (Delay=nDly, Vref=1)	1
6+(nVref*nDly)	Error Count (Delay=nDly, Vref=nVref)	1

The rows of the matrix (index nVref) correspond to the DRAM Mode Register value for VrefDQ.

The following equation is used to convert the row index to the VrefDQ:

VrefDQ= (row index) \* DiagVrefInc

To convert VrefDq to Volts, please see the Jedec specification for the DRAM protocol of interest.

The columns of the matrix are in units of 1/64\*UI.

72columns are correspond to the DQ delay (relative to DQS) -4/64\*UI: +68/64\*UI from the trained position.

```
Column Index 0 = Trained Position - 4/64*UI
Column Index 36 = Trained Position
```

Column Index 71 = Trained Position +68/64\*UI

In the case where the Trained position of TxDq is less than 36/64\*UI the column indexes correspond to:

Column Index 0 = Trained Position - Trained Position/64\* UI

```
Example test pseudocode:

CenterDelay = read (csr_txdqdly)

centerVoltage = read messageblock

For voltage (0 to max in steps DiagVreflnc)

For delays (max(0,centerDelay-36) to centerDelay+35){

For DiagXCnt{

For DiagLoopCnt {

Write diagAddr DiagRepeatCount times

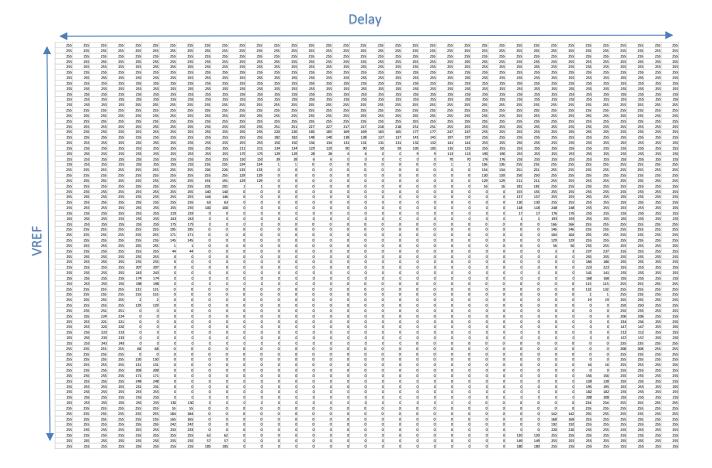
Read diagAddr DiagRepeatCount times
}//for

}//for

Record errors
}//for
```

#### **Example Messageblock ErrorCount Output**

TxEye nVref = 127 nDly = 72



## **5.8 TEST 0x6 : Rx Eye**

Field Used	Range	Description	
DiagPrbs	[0,2]	0: Reserved	
		1: Prbs23 mode	
		2: pattern mode	
DiagRepeatCount	[0, 127]	Number of extra bursts per loop(DiagMisc1=2)	
	[Don't care]	If DiagMisc1=0	
DiagLoopCount	[0,255]	How many extra loops to run	
DiagXCnt	[0,255]	How many times to iterate (0 and 1 will iterate once)	
DiagByte		Which byte to measure	
DiagLane	[0,8]	Which dq to measure	
DiagRank		Which rank to test	
DiagAddrHigh, DiagAddrLow		Row address to activate	
DiagPatternHigh, DiagPatternLow		32 bit-time repeating Pattern to send when	
		[ DiagPrbs==2 pattern mode ]	
DiagVrefInc	[1, 127]	Controls granularity of voltage domain. Larger number means less resolution.	
DiagMisc0	DiagMisc0[3:0] = 0	No filtering	
	DiagMisc0[3:0] = 1	Ignore Dqs_C bits	
	DiagMisc0[3:0] = 2	Ignore Dqs_T bits	
		All other values reserved	
DiagMisc1	DiagMisc1 = 0	Use Write Read FIFO	
	DiagMisc1 = 1	Use Read DQ Calibration	
		All other values reserved	
DiagMisc2	DiagMisc2 = 0	Scan all VREFS	
	DiagMisc2 = 1	Scan Only VREF0	

	DiagMisc2 = 2	Scan Only VREF1
	DiagMisc2 = 4	Scan Only VREF2
	DiagMisc2 = 8	Scan Only VREF3
		All other values reserved
DiagMisc3	DiagMisc3 = 0	No DFE Filtering
	DiagMisc3 = 1	Filter PrevVal=1
	DiagMisc3 = 2	Filter PrevVal=0
		All other values reserved
DiagMisc4[0]	DiagMisc4[0]=0	Use 2UI fine delay in RxClk dly
	DiagMisc4[0]=1	Use only 1 UI fine delay in RxClk dly

-			
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If DiagMisc1=1, Rx test runs with Read DQ Calibration. This will alter some mode register value at the SDRAM. The affected MR register are MR15, MR20, MR32 and MR40 in LPDDR4. The affected MR register are MR31, MR32, MR33 and MR34 in LPDDR5.

The RxEye test collects the receive eye associated with a specifc byte and bit. The eye is measured by running traffic while varying the Phy's VREF and RxClkDly delay settings. The test records how many errors occur at each delay and voltage setting and returns a matrix of encoded error counts through the DiagReturnData messageblock field.

RxEye sends a continuous group of DiagRepeatCount write bursts to the target row address using the data pattern provided. The write burst is followed by a continuous group of DiagRepeatCount read burst checking the contents of the memory addresses just written. If DiagLoopCount or diagXCnt is non-zero, the target row will then be overwritten and read back another DiagLoopCount\*DiagXCnt times. Once finished the test reads the errors on the target lane and stores the results. RxExe repeats this set of reads and writes for the powerset of all phy voltages and rxClkDelay settings, storing values all the while.

Current firmware only supports the read fifo option, which results in a fixed number of reads and writes for each loop iteration, which is 8 for LPDDR5 and 4 for LPDDR4.

Error counts for each (delay, voltage) pair are 16 bit values compressed into a single byte to save space. The compression scheme is as follows.

Compressed Result Value	Actual Error count
X=[0x0,0x7f]	X
X=[0x80,0xfe]	(X&0x7f) <<7 (approximate)
X=0xff	> 16256 (approximate)

DiagReturnData's results for RxEye are mapped as described below, including the dimensions of the error matrix (nVref x nDly) and the center point found by previous training stages in addition to the error matrix itself. Please note that the results are reported from minimum voltage to maximum voltage.

Version 1.40a

Byte Offset	Description	Size in Bytes
0	Number of Delays (nDly)	1
1	Number of Vrefs (nVref)	1
2	Trained phy VrefDAC0	1
3	Trained phy VrefDAC1	1
4	Trained phy VrefDAC2	1
5	Trained phy VrefDAC3	1
6	Trained Rxclkdly CSR Value	2
8	Error Count (Delay=0, Vref=0)	1
8+Dly	Error Count (Delay=Dly, Vref=0)	1
8+(nDly*Vref)+1	Error Count (Delay=1, Vref=1)	1
		••
8+(Vref*nDly)+Dly	Error Count (Delay=Dly, Vref=Vref)	1

The rows of the matrix (index nVref) correspond to the PHY Register value for VrefDACO.

The following equation is used to convert the row index to the VrefDAC0 setting:

VrefDAC0 = (row index) \* DiagVrefInc

To convert VrefDACO to Volts, please see the PUB databook description for PHY Register VrefDACO

The columns of the matrix are in units of 1/64\*UI.

38 columns correspond to the DQS delay (relative to DQ).

```
Since the insertion delay of DQS may be larger than DQ, the eye is mapped starting at -4/64*UI.

Column Index 0 = -4/64*UI

Column Index 4 = 0

Column Index 67 = +63/64*UI
```

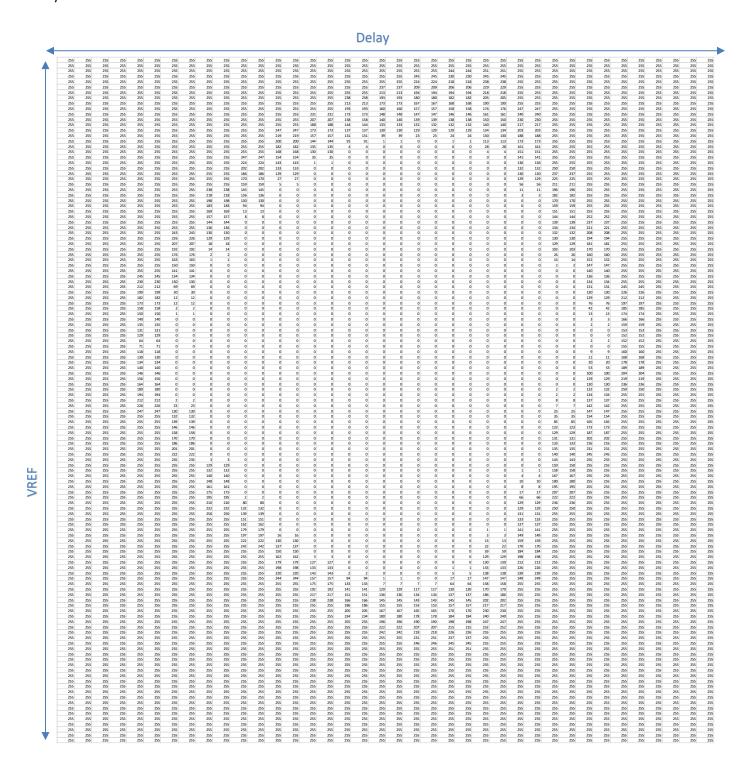
#### Example test pseudocode:

When

sweeping vref, the phy receiver range is limited to maintain trained difference between vrefDAC0, vrefDAC1, vrefDAC2 and vrefDAC3. Returned data is always relative to VREFDAC0

#### **Example Messageblock ErrorCount Output**

nVref = 127 nDly = 72



### 5.9 Test 9: Mode Register Write

The "Mode Register Write" test issues MRW command to the specified rank and channel in order to program a given mode register (MR).

#### **Mode Register Write test parameters**

Field used	Range	Description		
DiagRank	[0, 1]	Which rank to test		
DiagAddrLow	LPDDR4: [0, 40]	Which MR to write		
	DDR5: [0, 63]			
DiagAddrHigh	[0, 255]	Value to be written		
DiagChannel	[0, 1]	ChannelA or ChannelB		

After the Mode Register Write test, a MRR is issued by the firmware. The returned data of MRR is reported in DiagReturnData for user to compare with the intended written value specified at DiagAddrHigh.

#### MRR returned data issued after the MRW

Byte offset	Description	Size in bytes
0	Actual mode register value written	1

The sequence for this test is as follows:

#### LPDDR4/5:

- 1. All DRAMs on all channels and ranks are sent the power down exit and self-refresh exit commands
- 2. A MRS command is sent to the specified rank and channel
- 3. A MRR command is send to the specified rank and channel. Returned data is written to DiagReturnData.
- 4. All DRAMs on all channels and ranks are sent the self-refresh enter and power down commands
- 5. The test exits

## 5.10 Test 10: Mode Register Read

The "Mode Register Read" test issues a MRR command to the specified rank in order to read a given mode register (MR). This test is only supported for LPDDR5 memories. For LPDDR4, a subset of the mode registers can be read using the MPR Read test described in **Section 5.7**.

#### **Mode Register Read test parameters**

Field used	Range	Description
DiagRank	[0, 1]	Which rank to test
DiagAddrLow	LPDDR4: [0,40]	Which MR to read
	DDR5: [0,63]	

Results are reported beginning at the DiagReturnData message block field. MR value of all byte will be reported in DiagReturnData area.

The following table illustrates how the MR values are stored in the DiagReturnData area.

Mode Register Read test return data

Byte offset	Description	Size in bytes
0	Nnmber of bytes return N	2
2	Byte index (eg:byte0)	1
3	MRR value of this byte (eg:byte0)	1
4	Byte index (eg:byte1)	1
5	MRR value of this byte (eg:byte1)	1
(N*2)	Byte index (eg:byteN)	1
(N*2)+1	MRR value of this byte (eg:byteN)	1

#### The sequence for this test is as follows:

- 1. All DRAMs on all channels and ranks are sent the power down exit and self-refresh exit commands
- 2. A MRR command is sent to the specified rank
- 3. The returned MR values are stored in the return section of the diagnostics message block
- 4. All DRAMs on all channels and ranks are sent the self-refresh enter and power down commands
- 5. The test exits